| Electronic Pate | nt App | lication Fee | Transmi | ittal | | | |
|--|---------|---|----------|--------|-------------------------|--|--|
| Application Number: | 105 | 10551957 | | | | | |
| Filing Date: | 06- | 06-Oct-2005 | | | | | |
| Title of Invention: | | ADHESIVE RESIN COMPOSITION AND ADHESIVE AGENT IN FILM FORM, AND SEMICONDUCTOR DEVICE USING THE SAME | | | | | |
| First Named Inventor/Applicant Name: | You | Youichi Kodama | | | | | |
| Filer: | Rol | Robert G. Mukai/Michele Shockey | | | | | |
| Attorney Docket Number: | 018 | 018765-228 | | | | | |
| Filed as Large Entity | • | | | | | | |
| U.S. National Stage under 35 USC 371 Fil | ing Fee | 5 | | | | | |
| Description | | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | |
| Basic Filing: | | | | | | | |
| Pages: | | | | | | | |
| Claims: | | | | | | | |
| Miscellaneous-Filing: | | | | | | | |
| Petition: | | | | | | | |
| Patent-Appeals-and-Interference: | | | | | | | |
| Post-Allowance-and-Post-Issuance: | | | | | | | |
| Utility Appl issue fee | | 1501 | 1 | 1510 | 1510 | | |

Publ. Fee- early, voluntary, or normal

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | | |
|-----------------------------------|----------|-------------------|--------|-------------------------|--|--|--|
| Extension-of-Time: | | | | | | | |
| Miscellaneous: | | | | | | | |
| Printed copy of patent - no color | 8001 | 4 | 3 | 12 | | | |
| | Tot | Total in USD (\$) | | | | | |